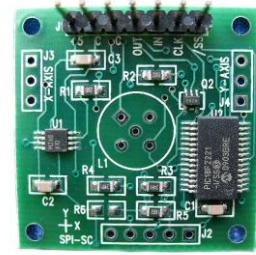


**1-6200-005**

# SPI Mini Signal Conditioner Board



Actual size

### Specifications

Power supply voltage	3 to 5 VDC (regulated)
Power supply current	6mA @ 5VDC 3.5mA @3.3VDC
Operating temp range (board only)	-40°C to +85°C
Storage temp range (board only)	-55°C to 0 +100°C
Angle range	0-100% of sensor range (16 bit,65535 counts max)
Board dimensions	1.25" x 1.25" or 32mm x 32mm square
Mounting hole and spacing	0.089" dia. and 1.05" (center to center)
Temp. sensor range	-40°C to +125°C (10 bit resolution)

### Signal Description J1

Pin #	Signal name	Direction	Description
1	Vcc	Input	Supply voltage input: + 3 to + 5 vdc regulated
2	GND	-	Ground – The reference for the digital signals and the supply voltage
3	GND	-	Ground – The reference for the digital signals and the supply voltage
4	SDO	Output	Slave output – SPI communications to master device 8 bit data from slave with clock from master
5	SDI	Input	Slave input – SPI communications from master device 8 bit data to slave with clock from master
6	SCK	Input	Slave clock – SPI input clock from master device Clock polarity = High, Clock in data = High to Low Data rate = 500kHz to 20MHz
7	/CS	Input	Chip select signal – signal to select slave device from master device (active during 8 bit transfer)

Please refer to the following link section 18.0 to 18.3 for a description of the SPI timing.

<http://ww1.microchip.com/downloads/en/DeviceDoc/39689f.pdf>

### Command Format

Command data (SDI) and clock (SCK) from master	Response data from slave (SDO) and clock from master (SCK)
Decimal 49 (ascii `1')	X axis high byte of 16 bit value
Decimal 50 (ascii `2')	X axis low byte of 16 bit value
Decimal 51 (ascii `3')	Y axis high byte of 16 bit value
Decimal 52 (ascii `4')	Y axis low byte of 16 bit value
Decimal 53 (ascii `5')	Board temperature high byte of 10 bit value
Decimal 54 (ascii `6')	Board temperature low byte of 10 bit value

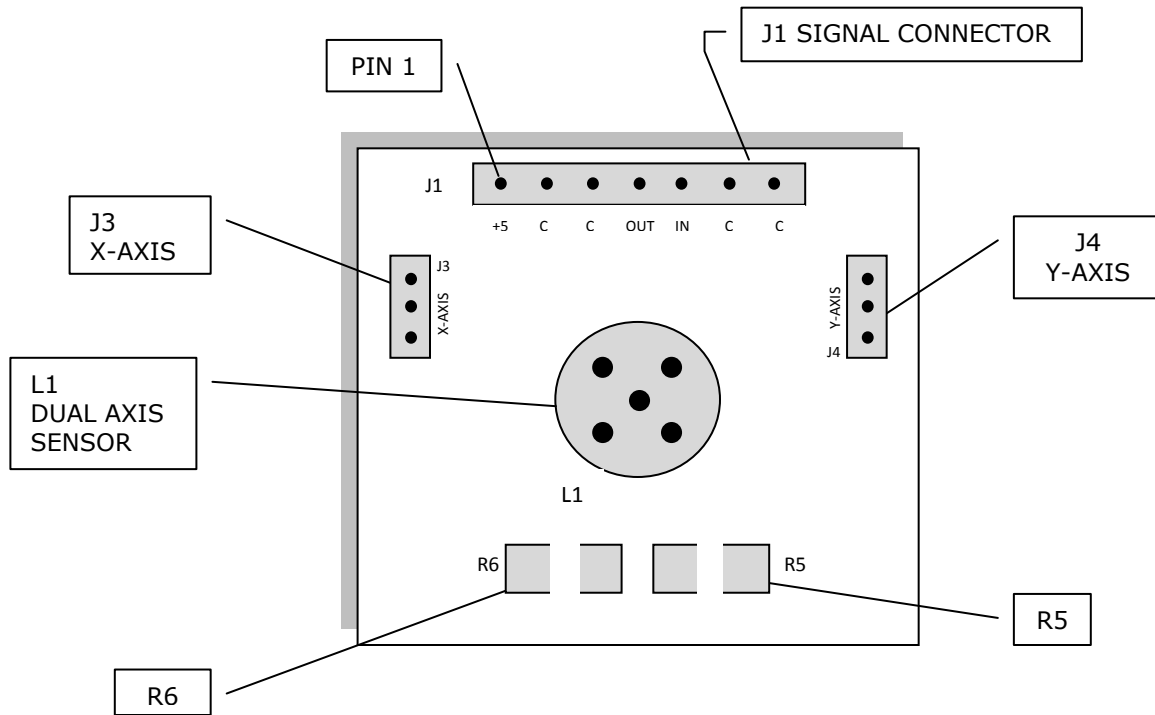
NOTE: Add 1 msec. delay between each 8 bit communications to SPI board.

NOTE: To convert the 10 bit data returned from the on board MCP9700 use the following formulas,

MCP9700 output voltage = 10 bit value / 1023 \* supply voltage

Temperature C = (MCP9700 output voltage – 0.5) / 0.010

**SPI signal conditioner board assembly**



**Sensor Configuration**

Sensor Configuration	Description
Dual Axis Sensor mounted on board (standard configuration)	<ul style="list-style-type: none"> <li>- Dual Axis is mounted in location L1</li> <li>- R5 is 10.0K ohms</li> <li>- R6 is not installed</li> </ul>
Single Axis sensors mounted off board	<ul style="list-style-type: none"> <li>- Single axis sensors are connected to J3 (x-axis) and J4 (y-axis)</li> <li>- No sensor is installed in L1</li> <li>- R5 is not installed</li> <li>- R6 is 1K ohms</li> </ul> <p>Note: if R5 is not removed then R6 must be less than 100 ohms</p>

NOTE: J2 is for factory use only.